

FDD050N03B N-Channel PowerTrench[®] MOSFET 30V, 90A, 5mΩ

Features

- $R_{DS(on)} = 3.7 m\Omega$ (Typ.)@ $V_{GS} = 10V$, $I_D = 25A$
- · Fast Switching Speed
- · Low gate charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant



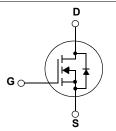
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC to DC Convertors / Synchronous Rectification





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter	FDD050N03B	Units	
V _{DSS}	Drain to Source Voltage			30	V
V _{GSS}	Gate to Source Voltage			±16	V
۱ _D		- Continuous (T _C = 25°C, Silic	- Continuous (T _C = 25°C, Silicon Limited)		
	Drain Current	- Continuous (T _C = 100 ^o C, Sil	- Continuous (T _C = 100 ^o C, Silicon Limited)		
		- Continuous (T _C = 25 ^o C, Pac	- Continuous (T _C = 25°C, Package Limited)		
I _{DM}	Drain Current	- Pulsed	- Pulsed (Note 1)		A
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	72	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	2	V/ns
P _D	Dewer Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		65	W
	Power Dissipation	- Derate above 25°C	- Derate above 25°C		W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	Ratings	Units
R_{\thetaJC}	Thermal Resistance, Junction to Case	2.3	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 6	i) 40	0/11

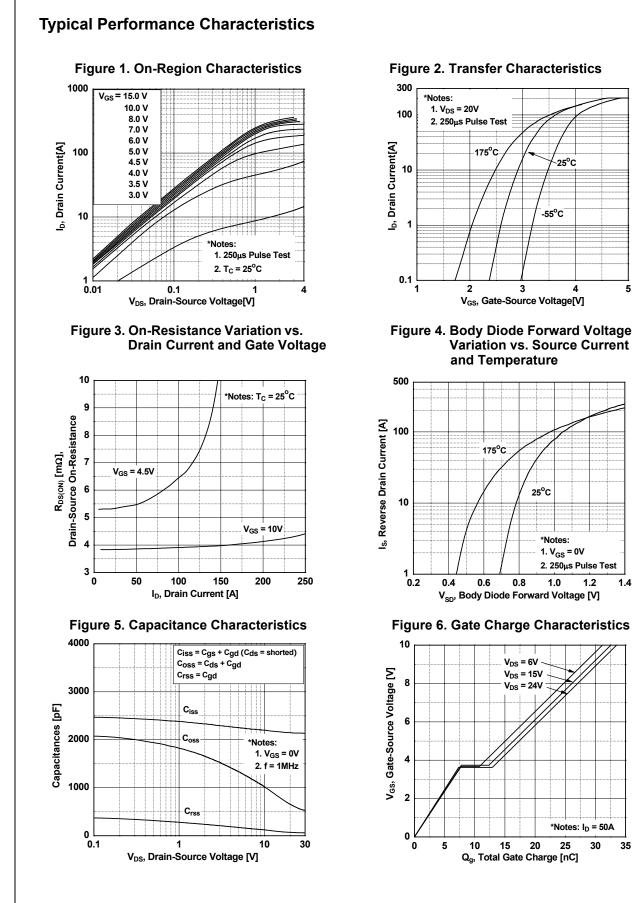
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Device Ma	Device Marking Device Pack		Package	ge Reel Size Tap			e Width		Quantity		
FDD050	FDD050N03B FDD050N03B D-PA				330mm	1	6mm		2500		
Electrica	I Char	acteristics T _c =	25°C unless o	therwise n	oted						
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units		
Off Charac	teristic	S									
BV _{DSS}	Drain to Source Breakdown Voltage		oltage	I _D = 250μA, V _{GS} = 0V, T _C = 25 ^o C			30	-	-	V	
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$		eakdown Voltage Temperature		$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	13	-	mV/º0		
I _{DSS}	Zero G	Gate Voltage Drain Current		V _{DS} = 24V, V _{GS} = 0V			-	-	1	μA	
I _{GSS}	Gate to	ate to Body Leakage Current		$V_{GS} = \pm 16$	V, V _{DS} = 0V		-	-	±100	nA	
On Charac	toristic	e									
V _{GS(th)}		s hreshold Voltage		$V_{00} = V_{00}$	Lo = 250µA		1.25	2.0	3.0	V	
• GS(th)		Static Drain to Source On Resistance		$V_{GS} = V_{DS}, I_D = 250\mu A$ $V_{GS} = 10V, I_D = 25A$ $V_{GS} = 4.5V, I_D = 15A$				3.7	5.0	-	
R _{DS(on)}	Static D							5.2		mΩ	
9 _{FS}	Forwar	ward Transconductance		V _{DS} = 5V,		(Note 4)	-	169	-	S	
Dynamic C	haract	eristics	I			¥					
C _{iss}		ut Capacitance			-	2160	2875	pF			
C _{oss}		It Capacitance rse Transfer Capacitance Gate Charge at 10V to Source Gate Charge Charge Threshold to Plateau to Drain "Miller" Charge		V _{DS} = 15V, V _{GS} = 0V f = 1MHz		-	805	1070	pF		
C _{rss}						-	85	130	pF		
Q _{g(tot)}				$y_{1} = 15y_{1} = 500$			-	33	43	nC	
Q _{gs}				V _{DD} = 15V, I _D = 50A V _{GS} = 10V	-	7.8	-	nC			
Q _{gs2}						-	3.8	-	nC		
Q _{gd}				(Note 4,5)			-	4.6	-	nC	
Switching	Charac	teristics				•					
t _{d(on)}						_	14.5	39	ns		
t _r		n Rise Time		V_{DD} = 15V, I _D = 50A V _{GS} = 10V, R _{GEN} = 4.7Ω		-	4.5	18	ns		
t _{d(off)}		f Delay Time		VGS - 10V	100, TGEN 4.132	-	-	30	70	ns	
t _f		f Fall Time		(Note 4,5)		(Note 4,5)	-	4.5	19	ns	
•			•					-			
I _s	Irce Diode Characteristics Maximum Continuous Drain to Source Diode Forward Current					-	-	90*	A		
I _{SM}		Maximum Pulsed Drain to Source Diode Fo				-	-	360	A		
V _{SD}		Source Diode Forward		$V_{GS} = 0V,$			-	-	1.3	V	
t _{rr}		e Recovery Time	-	$V_{GS} = 0V, I_{SD} = 50A$			-	33	-	ns	
Q _{rr}		se Recovery Charge		$dI_{F}/dt = 100A/\mu s $ (Note 4)		-	19	-	nC		
Notes: 1. Repetitive Ratin 2. L = 1mH, I _{AS} = 3. I _{SD} ≤ 50A, di/dt 4. Pulse Test: Puls	g: Pulse widt 12A, V_{DD} = 2 \leq 200A/ μ s, V se width \leq 30 pendent of C	h limited by maximum junction 7V, $R_G = 25\Omega$, Starting $T_J = 25^{\circ}$ $_{DD} \leq BV_{DSS}$, Starting $T_J = 25^{\circ}$ $\Omega\mu$ s, Duty Cycle $\leq 2\%$ perating Temperature Typical	5°C C	·					1		

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Figure 2. Transfer Characteristics

25°C

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1.2

*Notes: I_D = 50A

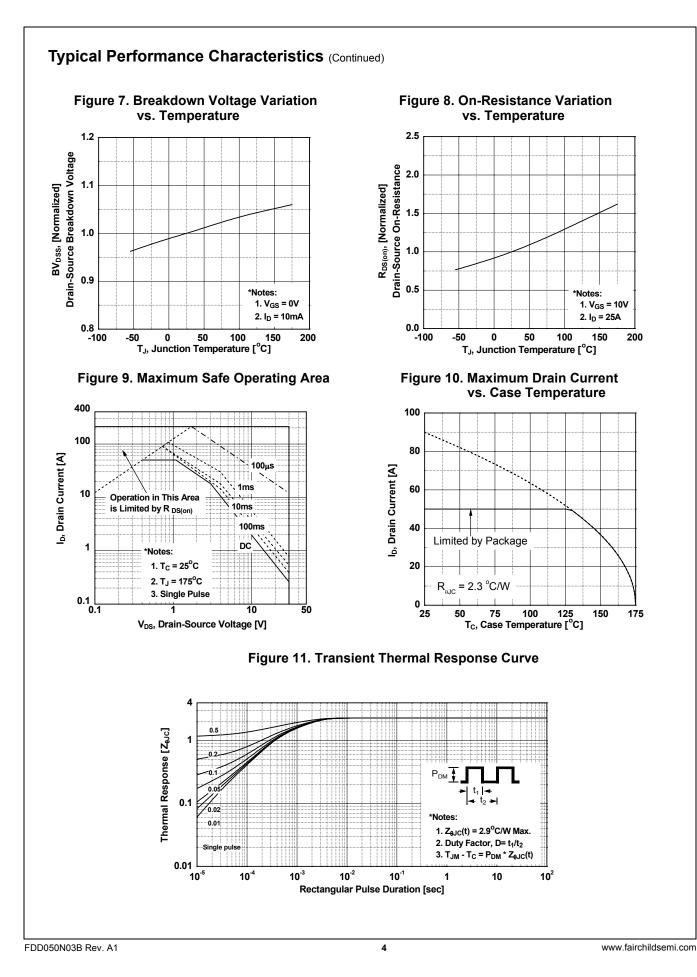
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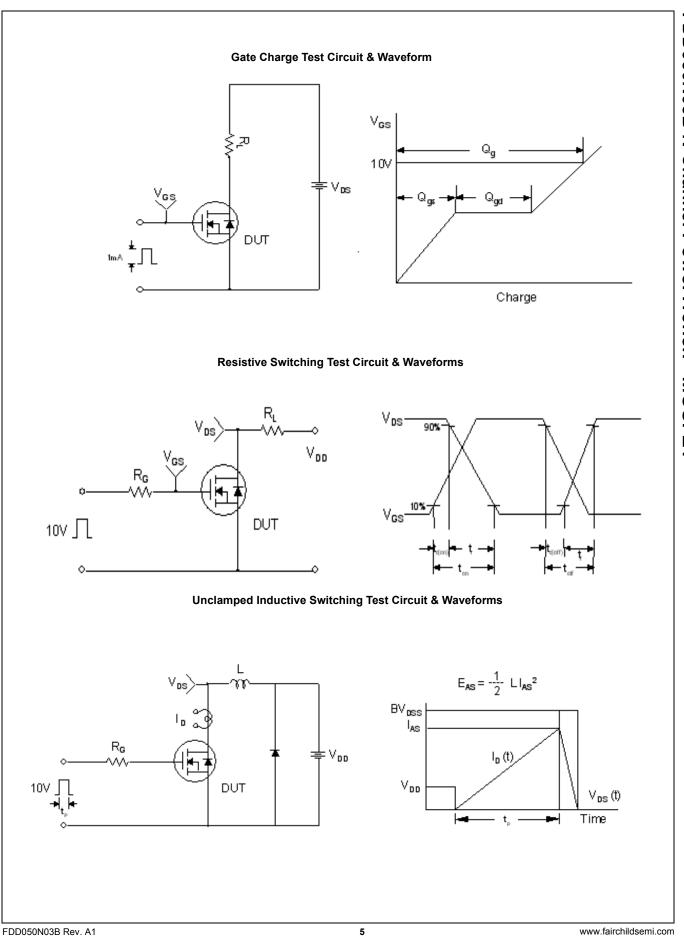
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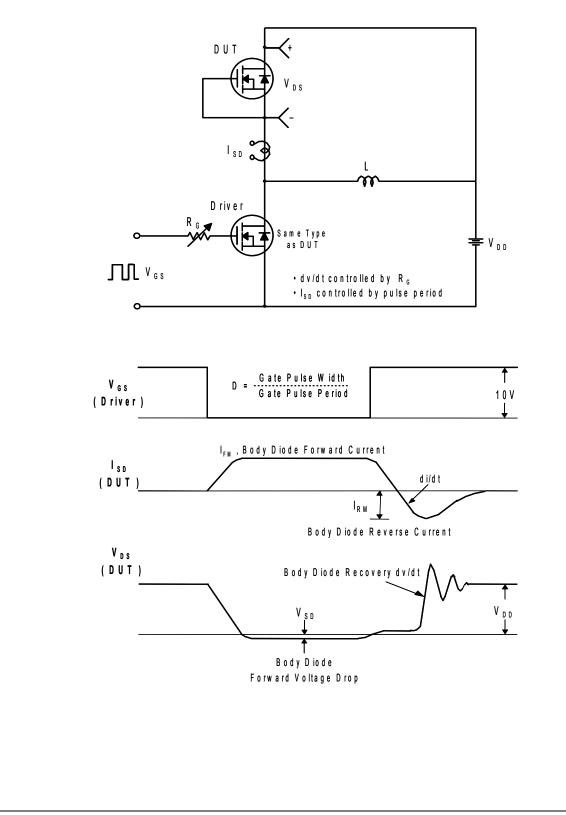
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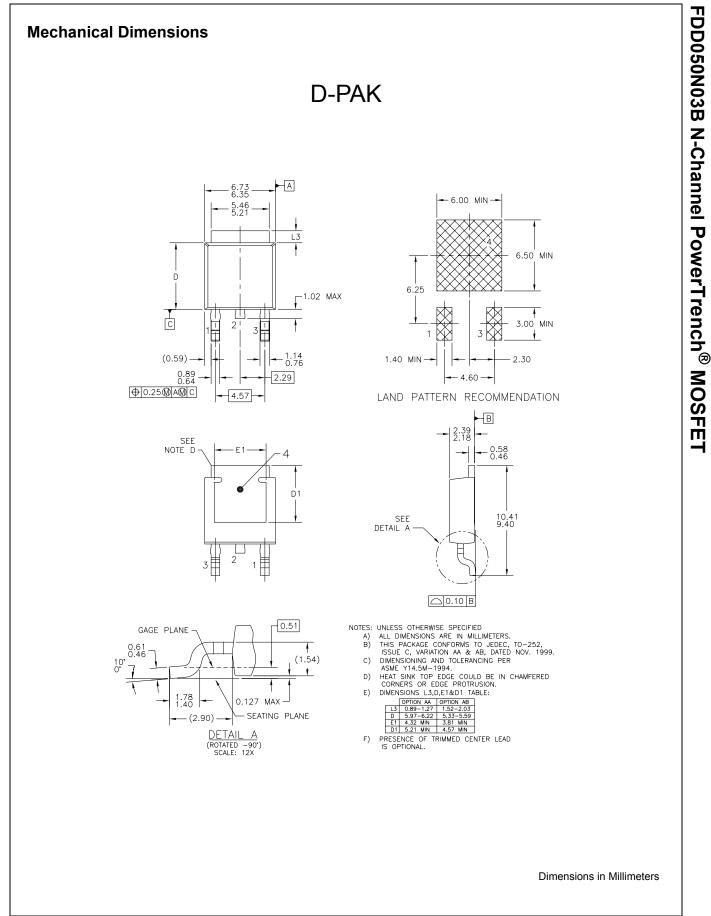


Peak Diode Recovery dv/dt Test Circuit & Waveforms

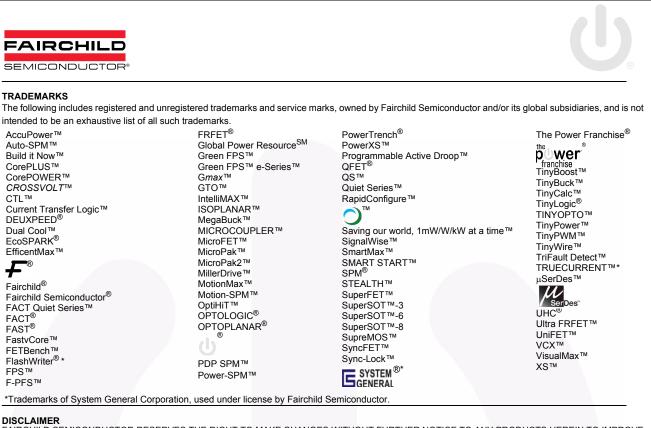


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